SM844256



10 Gigabit Ethernet and SONET, 6 Output, Ultra-Low Jitter LVDS Frequency Synthesizer

General Description

The SM844256 provides a low-noise timing solution for high speed, high accuracy synthesis of clock signals. Common applications include SONET, Gigabit Ethernet, 10 Gigabit Ethernet, and similar networking standards. It includes a power reduction methodology, along with a patented RotaryWaveTM architecture that provides a very stable clock with very low noise.

Power supplies of either 3.3V or 2.5V are supported, with superior jitter and phase noise performance. The device synthesizes different low noise LVDS output frequencies such as 125MHz, 156.25MHz, 312.5MHz, and 625MHz for Ethernet applications; 77.76MHz, 155.52MHz, 311.04MHz, and 622.08MHz for SONET applications. The crystal reference frequencies used include 25MHz and 19.44Mhz for Ethernet and SONET applications, respectively.

The SM844256 is an excellent replacement for IDT Femtoclocks, with improved accuracy, power consumption, waveform integrity, and jitter.

Data sheets and support documentation can be found on Micrel's web site at: www.micrel.com.

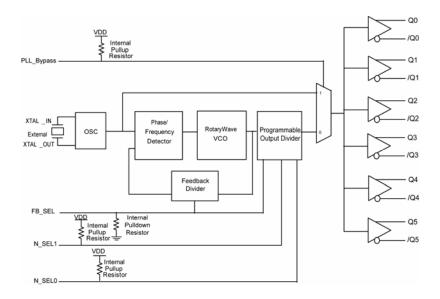
Features

- · Generates six LVDS outputs
- 2.5V or 3.3V operating range
- Typical phase jitter @ 125MHz
 (1.875MHz to 20MHz): 80 fs (typical) @ 3.3V
- 75MHz to 625MHz output frequencies
- · Industrial temperature range
- Green, RoHS, and PFOS compliant
- Available in 24-pin TSSOP EPAD
- Operating supply modes: Core/Output
 3.3V/3.3V, 3.3V/2.5V, 2.5V/2.5V

Applications

- SONET
- Gigabit Ethernet
- 10-Gigabit Ethernet
- Infiniband

Block Diagram



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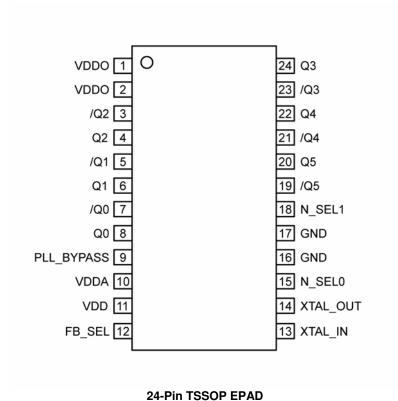
Ordering Information^(1, 2)

Part Number	Marking	Shipping	Junction Temperature Range	Package
SM844256KA	844256	Tube, Tape & Reel	–40° to +85°C	24-Pin TSSOP EPAD

Notes:

- 1. Devices are Green, RoHS, and PFOS Compliant.
- 2. Lead finish is 100% matte tin.

Pin Configuration



(Top View)

Pin Description

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1, 2	V_{DDO}	PWR		2.5V or 3.3V Power Supply
3, 4	/Q2, Q2	O, (DIF)	LVDS	Differential Clock Output
5, 6	/Q1, Q1	O, (DIF)	LVDS	Differential Clock Output
7, 8	/Q0, Q0	O, (DIF)	LVDS	Differential Clock Output
				Pull-Up 45k, Single-Ended Input Select Pin.
9	PLL_BYPASS	I, (SE)	LVCMOS	Logic (0) = PLL Output
				Logic (1) = Xtal Reference
10	V_{DDA}	PWR		Analog 3.3V or 2.5V Power Supply
11	V_{DD}	PWR		3.3V or 2.5V Power Supply
12	FB_SEL	I, (SE)	LVCMOS	Pull-Down 45k, Single-Ended Input Select Pin
13	XTAL_IN	I, (SE)	12pF crystal	Crystal Reference Input, no load caps needed.
14	XTAL_OUT	O, (SE)	12pF crystal	Crystal Reference Output, no load caps needed.
15	N_SEL0	I, (SE)	LVCMOS	Pull-Up 45k, Single-Ended Input Select Pin
16, 17	GND	PWR		Ground
18	N_SEL1	I, (SE)	LVCMOS	Pull-Up 45k, Single-Ended Input Select Pin
19, 20	/Q5, Q5	O, (DIF)	LVDS	Differential Clock Output
21, 22	/Q4, Q4	O, (DIF)	LVDS	Differential Clock Output
23, 24	/Q3, Q3	O, (DIF)	LVDS	Differential Clock Output

Input and Output Frequency Table

XTAL (MHz)	FB_SEL	N_SEL1	N_SEL0	Outputs (MHz)	Application
24	0	0	0	600	-
24	0	0	1	300	-
24	0	1	0	150	SAS/SATA
24	0	1	1	120	-
25	0	0	0	625	10 Gigabit Ethernet
25	0	0	1	312.50	10 Gigabit Ethernet
25	0	1	0	156.25	10 Gigabit Ethernet
25	0	1	1	125	Gigabit Ethernet/Infiniband/PCI/PCI- E/PCI-X
18.75	1	0	0	600	-
18.75	1	0	1	300	-
18.75	1	1	0	150	SAS/SATA
18.75	1	1	1	75	SAS/SATA
19.44	1	0	0	622.08	10 Gigabit Ethernet/SONET
19.44	1	0	1	311.04	SONET
19.44	1	1	0	155.52	SONET
19.44	1	1	1	77.76	SONET
19.53125	1	0	0	625	10 Gigabit Ethernet
19.53125	1	0	1	312.5	10 Gigabit Ethernet
19.53125	1	1	0	156.25	10 Gigabit Ethernet
19.53125	1	1	1	78.125	10 Gigabit Ethernet

Absolute Maximum Ratings(1)

Operating Ratings⁽²⁾

Supply Voltage (V _{DDO})	+2.375V to +3.465V
Supply Voltage (V _{DD} , V _{DDA})	+2.375V to +3.465V
Ambient Temperature (T _A)	40°C to +85°C
Junction Thermal Resistance (3)	
TSSOP (θ _{JA})	32°C/W

DC Electrical Characteristics⁽⁴⁾

 $V_{DDA} = V_{DD} = 3.3V \pm 5\%$ or 2.5V $\pm 5\%$, $V_{DDO} = 2.5V \pm 5\%$, $T_A = -40$ °C to +85°C, unless noted.

Symbol	Parameter	Condition	Min	Тур	Max	Units
V_{DDO}	2.5V Operating Voltage		2.375	2.5	2.625	V
V_{DDA}, V_{DD}	3.3V Operating Voltage		2.375	3.3	3.465	V
I _{DDA}	Analog Supply Range	F _{OUT} = 156.25 MHz		55	TBD	mA
		F _{OUT} = 625.00 MHz		56		
I _{DD}	Core Supply Current	F _{OUT} = 156.25 MHz		13	TBD	mA
		F _{OUT} = 625.00 MHz		13		
I _{DDO}	I/O Supply Range	F _{OUT} = 156.25 MHz		195	TBD	mA
		F _{OUT} = 625.00 MHz		200		

 $V_{DDA} = V_{DD} = V_{DDO} = 3.3V \pm 5\%$, $T_A = -40$ °C to +85°C, unless noted.

Symbol	Parameter	Condition	Min	Тур	Max	Units
$egin{array}{l} V_{DDA}, \ V_{DD}, \ V_{DDO} \end{array}$	3.3V Operating Voltage		3.135	3.3	3.465	V
I _{DDA}	Analog Supply Range	F _{OUT} = 156.25 MHz		55	65	mA
		F _{OUT} = 625.00 MHz		56		
I _{DD}	Core Supply Current	F _{OUT} = 156.25 MHz		13	17	mA
		F _{OUT} = 625.00 MHz		13		
I _{DDO}	I/O Supply Range	F _{OUT} = 156.25 MHz		195	234	mA
		F _{OUT} = 625.00 MHz		200		

Notes:

- 1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
- 2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
- 3. Package thermal resistance assumes exposed pad is soldered (or equivalent) to the devices most negative potential on the PCB.
- 4. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

LVDS DC Electrical Characteristics (5, 6, 7)

 V_{DDA} = V_{DD} = 3.3V ±5% or 2.5V ±5%, V_{DDO} = 2.5V or 3.3V ±5%, T_A = -40°C to +85°C, unless noted.

Symbol	Parameter	Condition	Min	Тур	Max	Units
V _{OD}	Differential Output Voltage	Figure 1	275	350	475	mV
ΔV_{OD}	V _{OD} Magnitude Change				40	mV
Vos	Offset Voltage		1.15	1.25	1.50	V
ΔV _{OS}	V _{OS} Magnitude Change				50	mV

LVCMOS DC Electrical Characteristics⁽⁶⁾

 $V_{DDA} = V_{DD} = 3.3V \pm 5\%$ or 2.5V $\pm 5\%$, $V_{DDO} = 2.5V$ or 3.3V $\pm 5\%$, $T_A = -40$ °C to +85°C, unless noted.

Symbol	Parameter	Condition	Min	Тур	Max	Units
V _{IH}	Input High Voltage		2		V _{DD} +0.3	V
V _{IL}	Input Low Voltage		-0.3		0.8	V
I _{IH}	Input High Current (FB_SEL)	V _{DD} = V _{IN} = 3.465V			150	μА
I _{IH}	Input High Current (PLL_BYPASS), (N_SEL0), (NSEL1)	$V_{DD} = V_{IN} = 3.465V$			5	μА
I _{IL}	Input Low Current (FB_SEL)	V _{DD} = 3.465V, V _{IN} = 0V	-5			μА
I _{IL}	Input Low Current (PLL_BYPASS), (N_SEL0), (NSEL1)	V _{DD} = 3.465V, V _{IN} = 0V	-150			μА

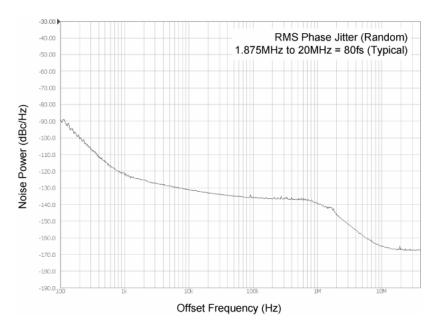
AC Electrical Characteristics⁽⁸⁾

 $V_{DDA} = V_{DD} = 3.3V \pm 5\%$ or 2.5V $\pm 5\%$, $V_{DDO} = 2.5V$ or 3.3V $\pm 5\%$, $T_A = -40$ °C to +85°C, unless noted.

Symbol	Parameter	Condition	Min	Тур	Max	Units
Fout	Output Frequency	Refer to Frequency Table	75		625	MHz
$T_{jit}(\varnothing)$	RMS Phase Jitter (Random)	125MHz, Integration Range:		80		fs
		(1.875MHz – 20MHz)				
T _{SKEW}	Output-to-Output Skew	Note 9			65	ps
T _R /T _F	LVDS Output Rise/Fall Time	20% – 80%	100	160	300	ps
ODC	Output Duty Cycle		45	50	55	%
T _{LOCK}	PLL Lock Time				20	ms

Notes:

- 5. See Figure 4 for load test circuit example.
- 6. The circuit is designed to meet the DC specifications shown in the above table(s) after thermal equilibrium has been established.
- 7. Outputs terminated 100Ω between Q and /Q. All unused outputs must be terminated.
- 8. The circuit is designed to meet the AC specifications shown in the above table(s) after thermal equilibrium has been established.
- 9. Defined as skew between outputs at the same supply voltage and with equal load conditions. Measured at the output differential crossing points.



Phase Noise Plot: 125MHz @ 3.3V

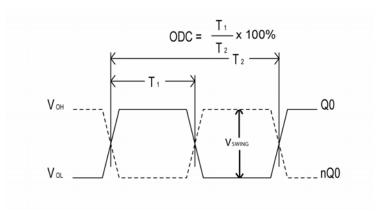


Figure 1. Duty Cycle Timing

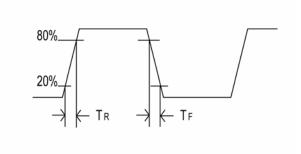


Figure 2. All Outputs Rise/Fall Time

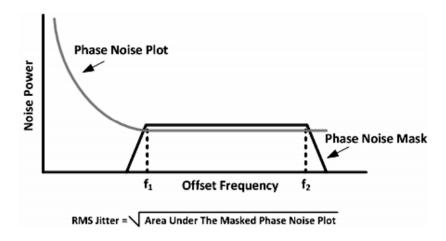


Figure 3. RMS Phase Noise/Jitter

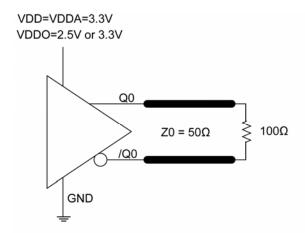


Figure 4. LVDS Output Load and Test Circuit

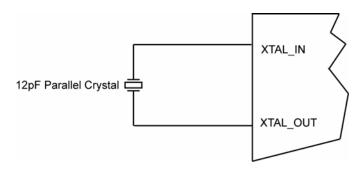
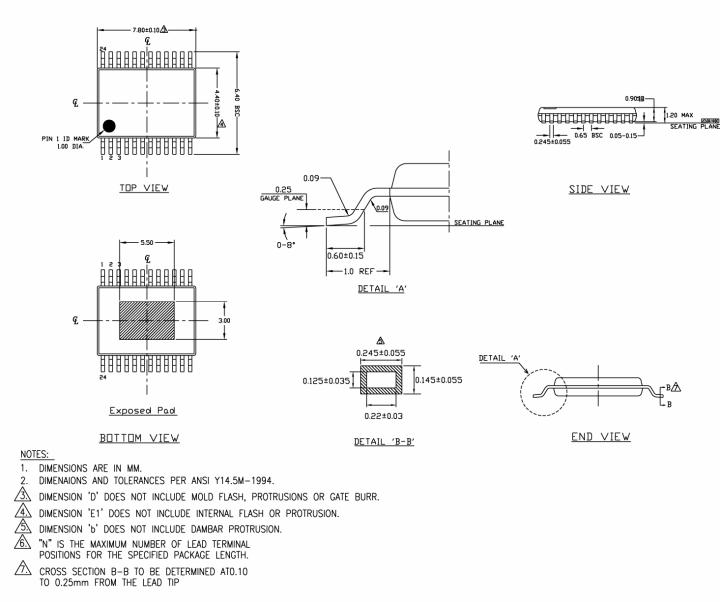


Figure 5. Crystal Input Interface

Package Information



24-pin Epad TSSOP

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